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2823

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:

Harry Q. Pon

Serial No.: 09/836,973

Filed: April 18, 2001

For: EMI and Noise Shielding for Multi-  
Metal Layer High Frequency Integrated  
Circuit Processes

§  
§ Art Unit: 2823  
§  
§  
§ Examiner: Deven Collins  
§  
§  
§  
§ Atty Docket: ITL.0452US  
§ P9563  
§

3/6/02  
7/13/02  
A.W.C.

Commissioner for Patents  
Washington, DC 20231

**RESPONSE TO RESTRICTION REQUIREMENT**

Sir:

In response to the restriction requirement mailed June 3, 2002, applicant elects

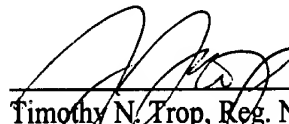
Group I (claims 13-21 and 24-30) without traverse.

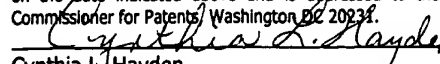
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Respectfully requested,

Date:

6/12/02

  
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Date of Deposit: June 12, 2002  
I hereby certify under 37 CFR 1.8(a) that this  
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Cynthia L. Hayden